TIL194, TIL195, TIL196, TIL194A, TIL195A, TIL196A TIL194B, TIL195B, TIL196B AC-INPUT OPTOCOUPLERS

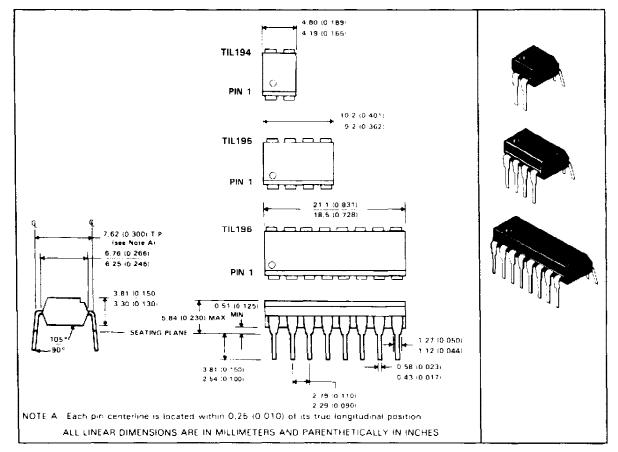
SOES001 D3287 MAY 1989 - REVISED SEPTEMBER 1989

- AC Signal Input
- Gallium-Arsenide Diode Infrared Source
- Source Is Optically Coupled to Silicon N-P-N Phototransistor
- Choice of One, Two, or Four Channels
- Choice of Three Current-Transfer Ratios
- High-Voltage Electrical Isolation 3.535 kV Peak (2.5 kV rms)
- Plastic Dual-In-Line Packages
- UL Listed File #E65085

description

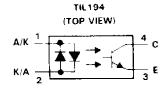
These optocouplers consist of two gallium-arsenide light-emitting diodes connected in a reverse-parallel configuration for ac-input applications and a silicon n-p-n phototransistor per channel. The TII 194 has one channel in a 4-pin package, the TIL195 has two channels in an 8-pin package, and the TIL196 has four channels in a 16-pin package. The standard devices, TIL194, TIL195, and TIL196, are tested for a current-transfer ratio of 20% minimum. Devices selected for a current-transfer ratio of 50% and 100% minimum are designated with the suffix A and B respectively.

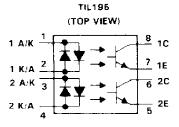
mechanical data

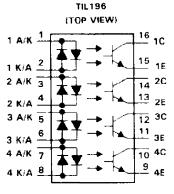


TIL194, TIL195, TIL196, TIL194A, TIL195A, TIL196A TIL194B, TIL195B, TIL196B AC-INPUT OPTOCOUPLERS

schematic diagrams







absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

Input-to-output voltage (see Note 1) ± 3.535 kV peak or dc (± 2.5 kV rms)
Collector-emitter voltage (see Note 2)
Emitter-collector voltage
Input diode continuous forward current at (or below) 25°C free-air temperature
(see Note 3)
Continuous power dissipation at (or below) 25 °C free-air temperature:
Phototransistor (see Note 4)
Input diode plus phototransistor per channel (see Note 5)
Storage temperature range55°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds

- NOTES: 1. This rating applies for sine wave operation at 50 or 60 Hz. Service capability is verified by testing in accordance with UL requirements.
 - 2. This value applies when the base-emitter diode is open circuited.
 - 3. Denate linearly to 100 $^{\rm o}{\rm C}$ free air temperature at the rate of 0.67 mA/ $^{\rm o}{\rm C}$
 - 4. Denate linearly to 100°C free air temperature at the rate of 2 mW/°C.
 - 5. Derate linearly to 100°C free air temperature at the rate of 2.67 mW/°C.

electrical characteristics at 25°C free-air temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
V(BR)CEO	Collector-emitter breakdown voltage		IC = 0.5 mA	IF = 0	35			V
V(BR)ECO	Emitter-collector breakdown voltage		I _C = 100 μA,	IF = 0	7			V
IC(aff)	Off-state collector current		V _{CE} = 24 V.	I _F = 0			100	nA
CTR [†]	Current transfer ratio	TIL194, TIL195, TIL196	l _F = 5 mA,	V _{CE} = 5 V	20%			
		TIL194A, TIL195A, TIL196A			50%			
		TIL194B, TIL195B, TIL196B			100%			
VF [†]	Input diode static forward voltage		IF = 2Ω mA				1.4	٧
VCE(sat)	Collector-emitter saturation voltage		lp = 5 mA,	Ic = 1 mA			0.4	V
C _{iO}	Input-to-output capacitance		V _{in-out} = 0, See Nate 6	f = 1 MH2		1		рF
rio	Input-to-output internal resistance		V _{in-out} = ±1 kV. See Note 6			10 ¹¹		Ω
IC(an)1 IC(an)2	On-state coll (see Note 7)	ector current symmetry ratio	V _{CE} = 5 V.	IF = 5 mA	1		3	

[†]These parameters apply to either direction of the input current.

NOTES 6: These parameters are measured between all input-diode leads shorted together and all phototransistor leads shorted together

7. The higher of the two values of I_{Clon} generated by the two diodes is taken as I_{Clon} .



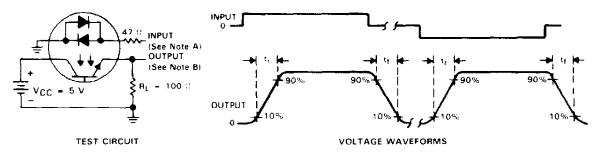
switching characteristics at 25 °C free-air temperature

	PARAMETER	TEST CONDITIONS	TYP	UNIT
t,†	Rise time	V _{CC} = 5 V. I _{C(on)} = 2 mA.	6	jıS
t _f †	Fall time	R _L 100 Ω, See Figure 1	6	μS

^{*}These parameters apply to either direction of the input current.

PARAMETER MEASUREMENT INFORMATION

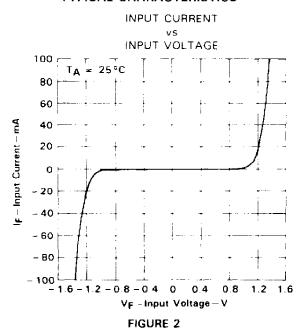
Adjust amplitude of input pulse for IC(on) = 2 mA



NOTES: A. The imput waveform is supplied by a generator with the following characteristics: $Z_0 \sim 50~\Omega_c t_f \leq 15$ ns, duty cycle = 1% B. The output waveform is monitored on an oscilloscope with the following characteristics: $t_f \leq 12$ ns: $R_i \geq 1~M\Omega/C_i \leq 20~pF$

FIGURE 1. SWITCHING TIMES

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

100

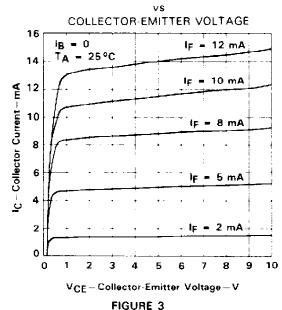
10

1

0.001

0.1

TIL194, TIL195, TIL196 COLLECTOR CURRENT



IC(on) -- Normalized Collector Current 0.1 0.01

0.4

VCE - 5 V

Normalized to Ip

- 25°C

IF-Input Current-mA FIGURE 4

10

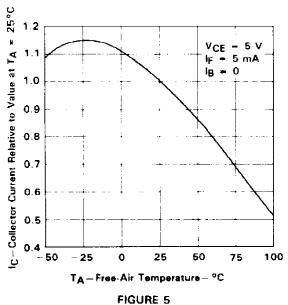
40 100

NORMALIZED ON-STATE COLLECTOR CURRENT

INPUT-DIODE FORWARD CURRENT

RELATIVE ON-STATE COLLECTOR CURRENT vs

FREE-AIR TEMPERATURE



TYPICAL COLLECTOR-EMITTER SATURATION VOLTAGE

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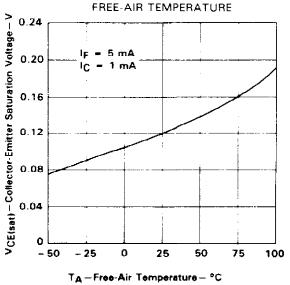


FIGURE 6

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